



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Masahiko HIRATA et al

Application No: 10/533,288

Art Unit: 1742

Filing date: November 3, 2005

Examiner: Sikyin Ip

For: LEAD-FREE SOLDER AND SOLDERED ARTICLE

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Official Action mailed on December 1, 2006, the Applicants request that the present application be amended as shown below. A Request for Continued Examination and a petition for a one-month extension of time have been filed together with this response, extending the period for response to and including April 2, 2007.

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